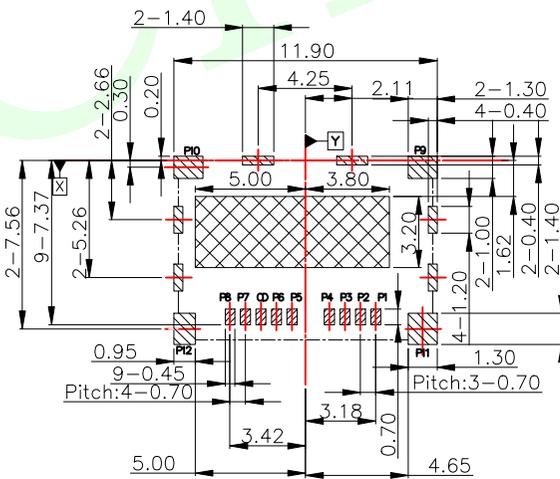
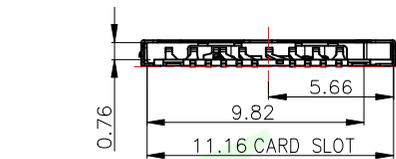
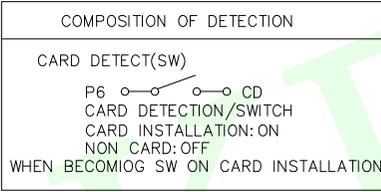
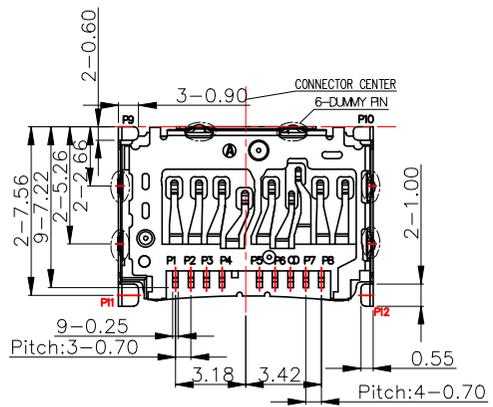
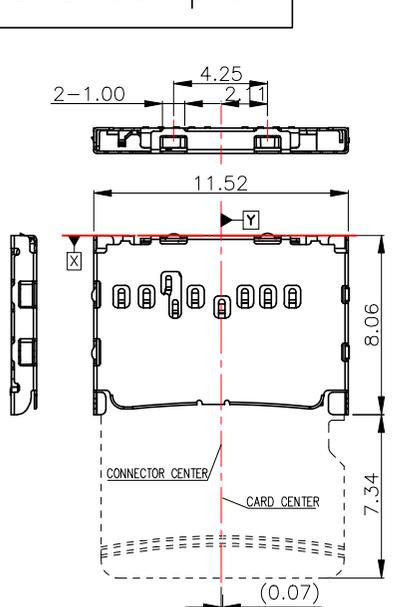
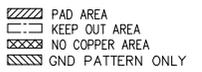


RoHS Compliant



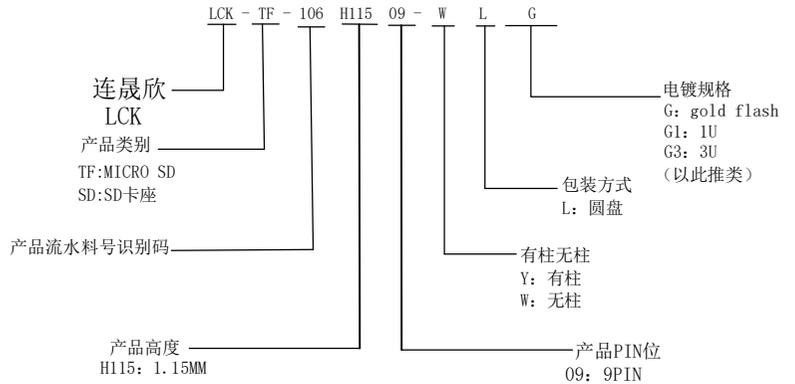
Pin Define	
P1	DAT2
P2	CD/DAT3
P3	CMD
P4	VDD
P5	CLK
P6	VSS
CD	CARD DETECT
P7	DAT0
P8	DAT1
P9-P12	GND

RECOMMEND P.C.B LAYOUT
(General tolerance ± 0.05)



- NOTE:
- Material:
 - 1-1 Housing: High Temperature Thermoplastic, (LCP MG350) Color Black UL 94V-0.
 - 1-2 Contact: Phosphor Bronze(C5210R-SH T=0.12mm)
 - 1-3 Cover: SUS304-H T=0.10mm
 - Plating:
 - 2-1 Contact terminal: Contact area: Gold 2u" Min. Middle Pd-Ni 8u" min. Solder area: Gold 1u" Min. Underplating: Ni overall 80U" Min.
 - 2-2 Cover: Underplating: Ni overall 30U" Min. Solder area: Gold 1u" Min.
 - Specification:
 - 3-1. Contact Current Rating: 0.5 Amperes.
 - 3-2. Dielectric Withstanding Voltage: AC500V r.m.s.
 - 3-3. Insulation Resistance: 1000 Megohms Minimum At DC 500V.
 - 3-4. Contact Resistance: 100 mΩ Maximum.
 - 3-5. Mating Cycles: 5,000 Cycles.
 - 3-6. Operating Temperature: -25°C~+60°C.
 - Product Compliant to RoHS Directive 2002/95/EC and ELV 2000/53/EC
 - Part Must Comply Taisol HF WD-3-1-091 Specification.
 - Recommending A Metal More Than 0.15mm Thick. Please Confirm Solderability, If Use A Metal Mask Less Than 0.15mm Thick.

产品采购完整示意号: LCK-TF-106H11509-WLG



MEASURE POINT: QUADRANT POINT
TANGENCY POINT
INTERSECTION POINT

联晟欣连接器 (深圳) 有限公司
Lianshengxin Connector (Shenzhen) Co., Ltd

UNLESS OTHERWISE SPECIFIED, TOLERANCE:	DESIGN	Andy	DATE	2014.12.24	TITLE:		
	CHECKED		DATE		MICRO SD H1.15 CARD CONN		
	APPROVED		DATE				
X. ±0.25	PART NO: LCK-TF-106H11509-WLG				REV: 04	SCALE: 1:1	UNIT: mm
X.x ±0.20	DRAWING NO: 1020221205				SIZE: A4	SHEET: 1/1	
X.xx ±0.15							
ANGULAR ±3°							